



SCHUNK-AC

SCHUNK-RAC

MICRO-GRID 13TH CPU FANLESS



MICRO-GRID COMPUTER

- **Intel® 13th / 12th Gen Raptor Lake-S / Alder Lake-S Core™ i9/i7/i5/i3 up to TDP 65W**
- **Up to 64G DDR4 SO-DIMM 3200 MHz**
- **2 x DP, 2 x LAN, 6x USB**
- **2x 2.5" Easy swap SSD Tray**
- **2 x PCIe Gen4 x 8 slot**
- **AC-IN 110~240V (Support Redundant)**
- **Operation Temp. -20°C to 60°C**

Specifications

SYSTEM

CPU	13th/12th Gen Intel® Raptor Lake-S/Alder Lake-S LGA1700 Socket Processor / Core i9/i7/i5/i3 Processor up to TDP 65W
Memory Capacity	32G DDR4 SO-DIMM 3200 MHz
Chipset	Q670

DISPLAY

GPU	Intel® UHD Graphics
Display Port	DisplayPort 1.4, DP++ Max resolution up to 4k (4096x2304@60Hz)
2 nd Display Port	DisplayPort 1.4, DP++ Max resolution up to 4k (4096x2304@60Hz)

EXPANSION

PCIe Slot	2 x PCIe Gen4 x 8 Slot
M.2	1x M.2 2280M-key (PCIe3.0 X4, SATAIII)

STORAGE

SATA	Up to 4TB SATAIII
M.2	Up to 2TB NVMe & SATAIII

ETHERNET

Ethernet	1 x Intel® I219-LM Giga LAN 1 x Intel® I225V 2.5 Giga LAN
----------	--

FRONT I/O

Power Button	1 x Power Button
Indicator	1 x HDD backlight / 1 x Power backlight
USB3.0	2 x USB 3.0

REAR I/O

Power Input	1 x C14 Plug 110~240V AC-IN (2 x C14 Plug 110~240V AC-IN with Redundant)
LAN	2 x RJ45GbE LAN(1 x GbE / 1 x 2.5GbE)
USB3.2	2 x USB 3.2
USB2.0	2 x USB2.0
DisplayPort	2 x DP

Storage	2 x Swap SSD Tray
---------	-------------------

POWER REQUIREMEN

Power Input	AC-IN 110~240V (With Redundant)
-------------	----------------------------------

OS SUPPORT LIST

OS	Windows® 11 64bit, / Windows® 10 IoT LTSC 64bit (LTSC 2021) /
----	---

MECHANICAL AND ENVIRONMENTAL

Dimension	220 x 315 x167 mm (W x D x H)
-----------	---------------------------------

Operating Temp.	-20°C to 60°C
-----------------	---------------

Storage Temp.	-40°C to 85°C
---------------	---------------

Relative Humidity	5% to 95%, non-condensing
-------------------	---------------------------

System Design	Fanless
---------------	---------

CERTIFICATION

IEC-61850-3 / IEEE-1613 / UL 62368-1 / EN60945 / CE / FCC

Ordering Information

SCX4X2-AC

Micro-Gird Fanless Computer with Intel 13th /12th Gen Intel® Raptor Lake-S/Alder Lake-S LGA1700 Socket Processor / Core i9/i7/i5/i3 Processor TDP 65W, up to 64G SO-DIMM DDR4 3200MHz, 2 × RJ45(1 x GbE / 1 x 2.5GbE), 2 x USB3.2, 2 x USB3.0, 2 x USB2.0, 2 x DP, 2 x SwapSSD Tray, AC-IN 110~240V , Operating Temperature -20°C~+60°C

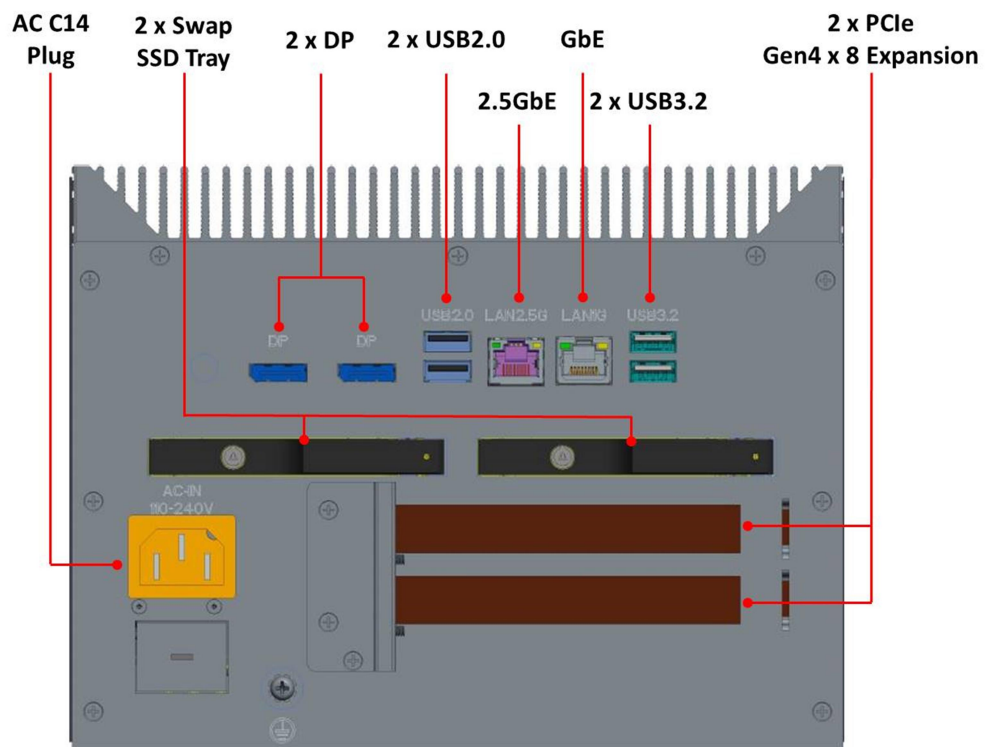
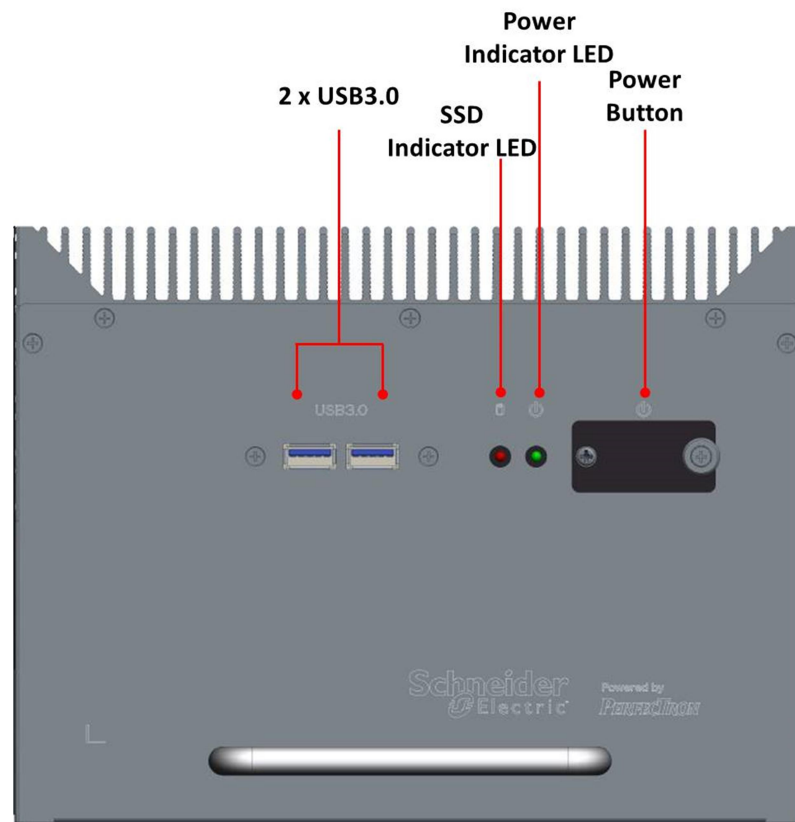
SCX4X2-RAC

Micro-Gird Fanless Computer with Intel 13th /12th Gen Intel® Raptor Lake-S/Alder Lake-S LGA1700 Socket Processor / Core i9/i7/i5/i3 Processor / TDP 65W, up to 64G SO-DIMM DDR4 3200MHz, 2 × RJ45(1 x GbE / 1 x 2.5GbE), 2 x USB3.2, 2 x USB3.0, 2 x USB2.0, 2 x DP, 2 x SwapSSD Tray, AC-IN 110~240V with redundant, Operating Temperature -20°C~+60°C

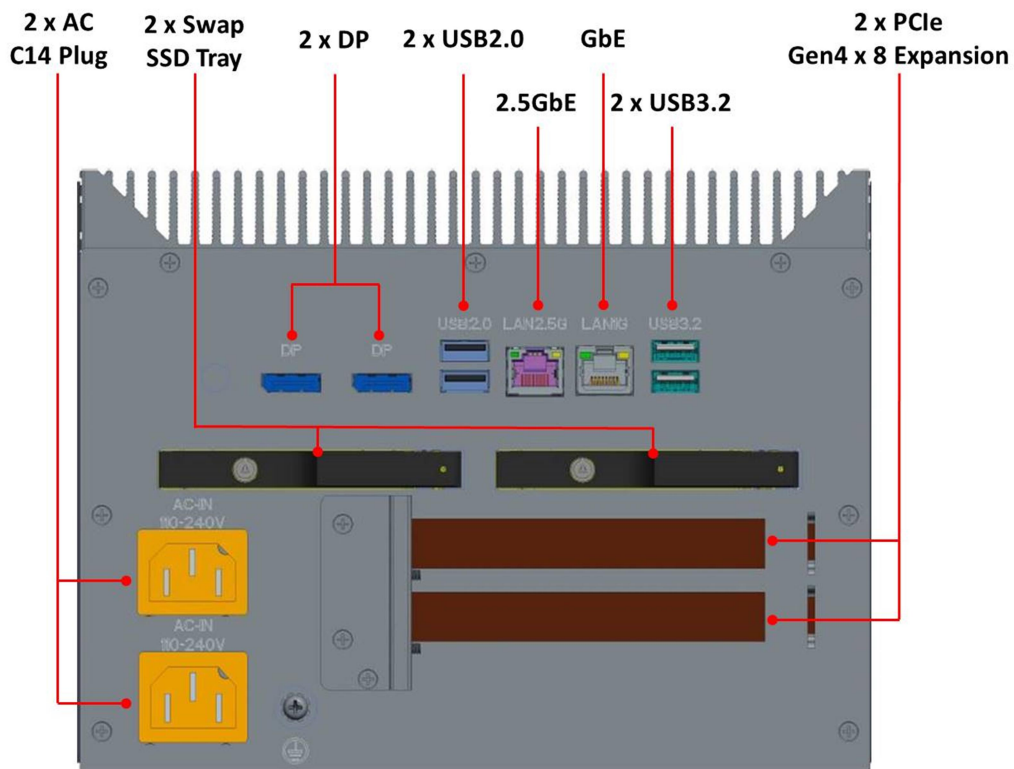
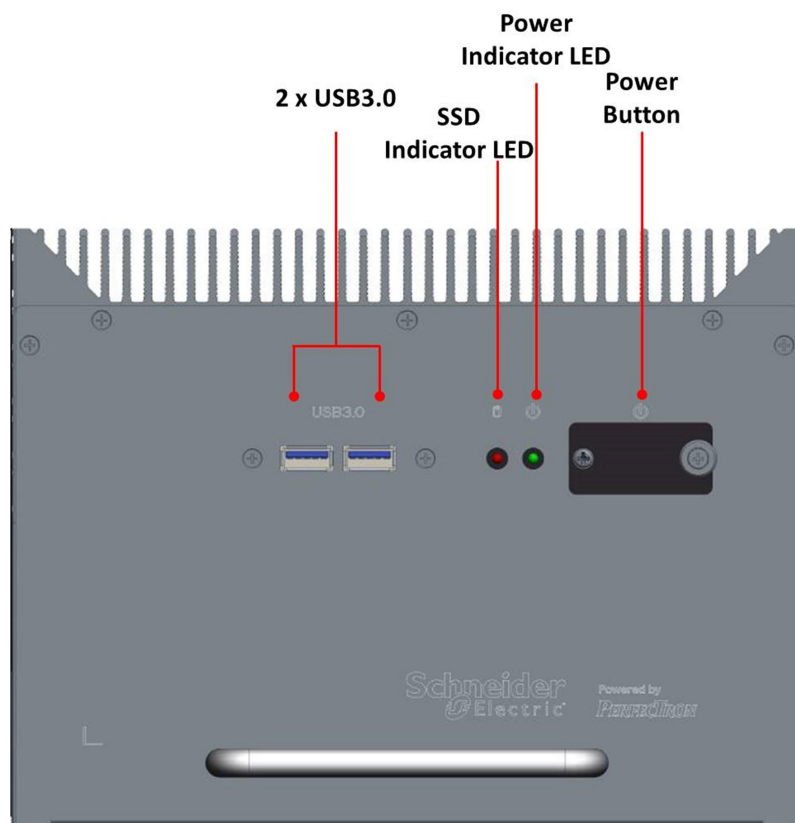
	SCH4X2-AC	SCH4X2-RAC
CPU	12/13th Gen Intel® Core i9/i7/i5/i3 Processor TDP 65W	
RAM	Up to 64GB SO_DIMM, DDR4-3200MHz	
Expansion	2 x PCIe Gen4 x 8 1 x M.2 2280(Gen3 x 4,SATAIII)	
Storage	Up to 4TB SATAIII Up to 2TB NVMe & SATAIII	
I/O	2 × RJ45, 6 x USB, 2 x DP, 2 x 2.5" SwapTray	
Power	AC-IN 110~240V	AC-IN 110~240V W/Redundant
Operation Temp.	-20°C~+60°C	

Appearance

SCH4X2-AC :

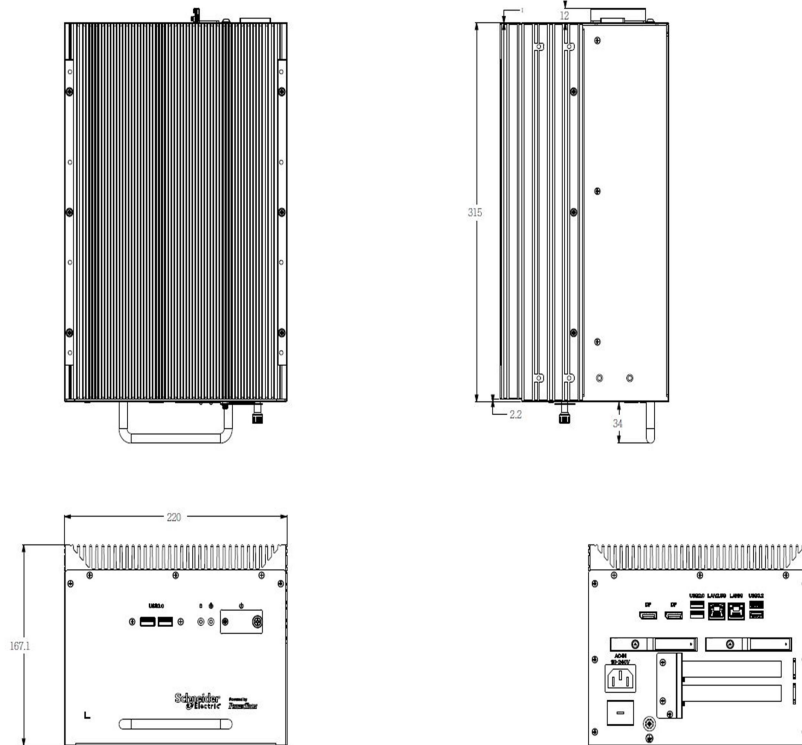


SCH4X2-RAC :



Drawing and Dimension

SCH4X2-AC :



SCH4X2-RAC :

